

DESCRIPTION

The PT2470 is a brushed-DC motor driver for printers, home appliances, industrial equipment, and other small machines. Dual pin logic inputs controls the H-bridge driver output current flows to manipulate the motor rotation in forward or reverse direction. With sufficient heat dissipation PCB area or add-on heatsinking, the peak output current may up to 3.6 Amps.

The PT2470 has built-in PWM current regulation circuits; it's a very useful function to limiting average current draws from power supply during motor rotates starts up and stalled. The PWM current regulation level is determinates by an external applied VREF reference voltage and current sense resistance attached in ISEN pin.

The PT2470 is protected from many fault conditions, including under voltage (UVLO), across-load short circuits (SCP) and over temperature shut down (TSD). The drive will disable the H-bridge output during fault condition is met, and device will automatically recovery when fault phenomena is removed.

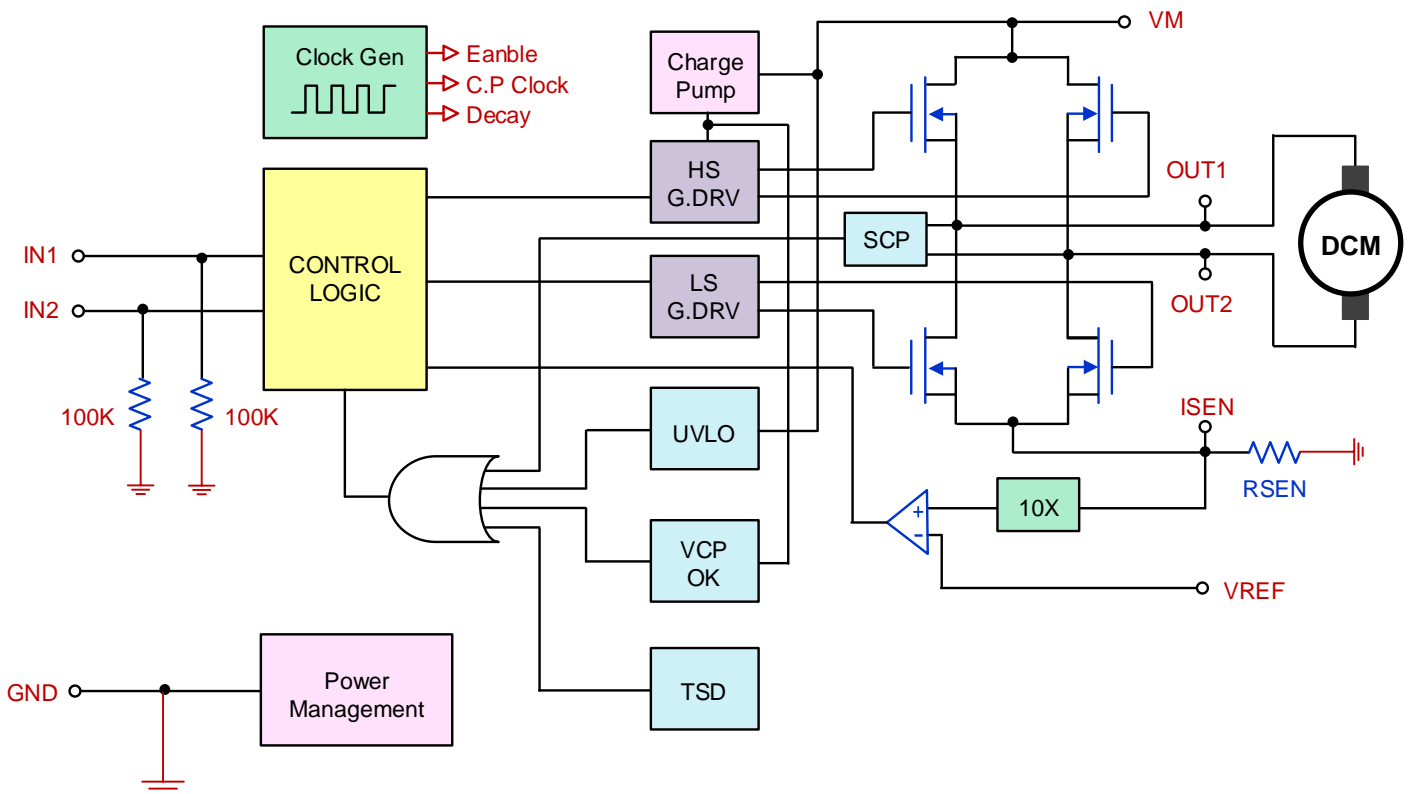
FEATURES

- H-Bridge Motor Driver for:
 - Single brushed DC Motor,
 - Single Winding of a Bipolar Stepping Motor
 - Solenoid High Side Driver
- Wide Operating Voltage : 9V to 36V
- Low Switches $R_{DS(on)}$ (HS+LS) : 500m Ω (typ)
- Peak Current Output : 3.6 Amps
- H-bridge Control Interface
- PWM Current Regulation
- Low-Power Sleep Mode
- Small Package and Footprint
 - 8-Pin HSOP With Thermal PAD
- **Protection Features**
 - VM Under voltage Lockout (UVLO)
 - Across-Load Short Circuit Protection (SCP)
 - Over Thermal Shutdown (TSD)
 - Automatic Fault Recovery

APPLICATIONS

- Printers
- Home Appliances
- Industrial Equipment

BLOCK DIAGRAM



APPLICATION CIRCUIT

Drives brushed DC motor with PWM current regulation function.

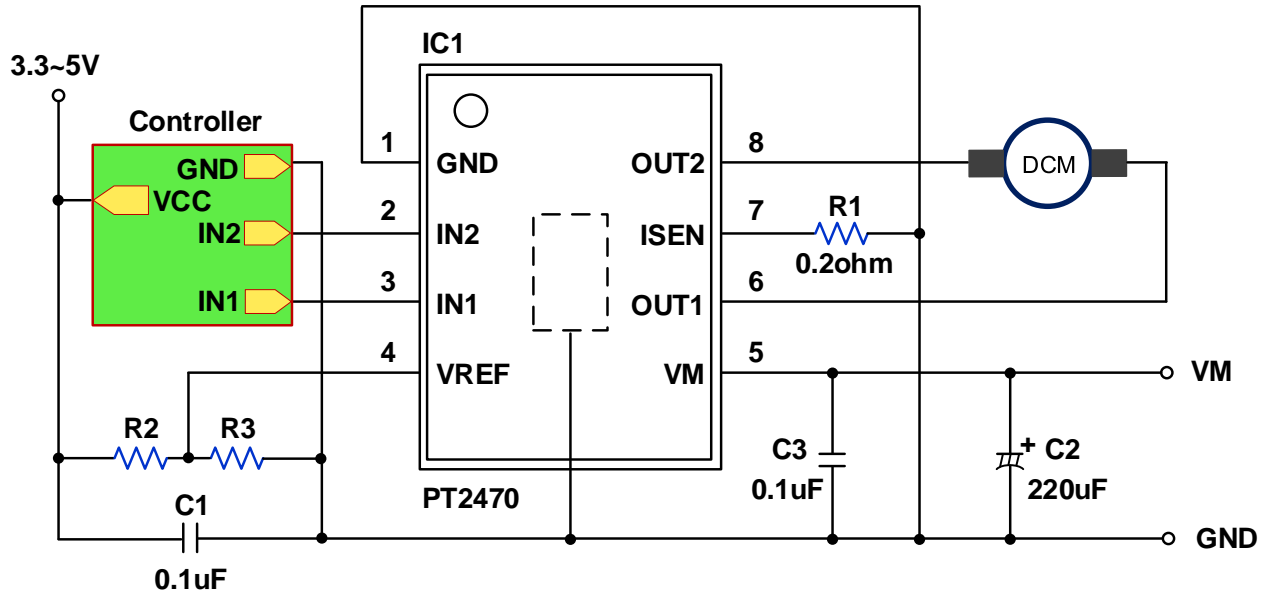


Figure 1. Typical Application Circuit

note(1) : The recommended value of R1 is from 0.1Ω to 0.5Ω, power dissipation from 0.5 to 1W.

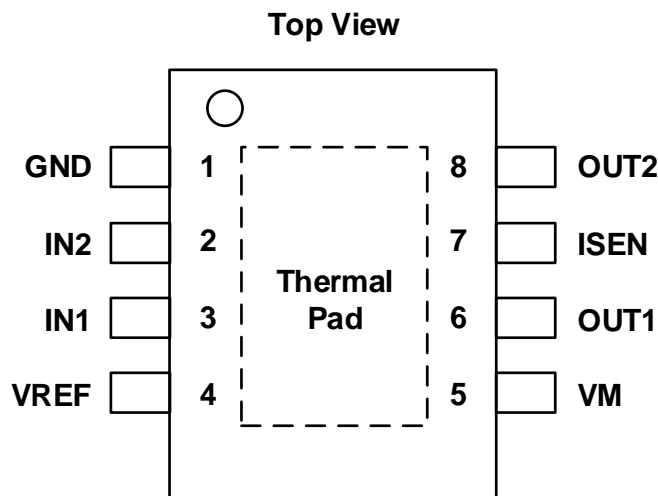
note(2) : Connects ISEN pin to power ground directly if PWM current regulation function is not necessary.

note(3) : VREF input voltage should not exceeds 5V.

ORDER INFORMATION

Valid Part Number	Package Type	Top Code
PT2470-HS	8 Pins, HSOP	PT2470-HS

PIN CONFIGURATION



PIN DESCRIPTION

Pin Name	Type	Description	Pin No.
GND	POWER	Ground for internal circuits, connects to power ground.	1
IN2	I	Control logic input 2, with 100KΩ internal pulldown.	2
IN1	I	Control logic input 1, with 100KΩ internal pulldown.	3
VREF	I	PWM current regulation reference input, input range from 0 to 5 V.	4
VM	POWER	Main power supply input for the IC.	5
OUT1	O	H-bridge output 1.	6
ISEN	O	H-bridge low side MOSFETs ground current path, refer to the application circuit for the recommends of sense resistor connection.	7
OUT2	O	H-bridge output 2.	8
THERMAL PAD	-	Thermal pad; must be soldered to the PCB ground plane. For improves thermal dissipation, a broad, multiple layer ground planes with multiple via connection is recommended.	-

FUNCTION DESCRIPTION

H-BRIDGE OUTPUT CONFIGURATION

The motor winding current direction is determinate by H-bridge output configuration, and it is maniples by control logic interface. Please refer to Table 1 for corresponds between input and output.

IN1	IN2	OUT1	OUT2	DESCRIPTION
0	0	HiZ	HiZ	Coast mode. The H-bridge is disabled and whole chip entering sleep mode after Tslp time (~1mS).
0	1	L	H	Reverse mode (Output current from OUT2 to OUT1)
1	0	H	L	Forward mode (Output current from OUT1→OUT2)
1	1	L	L	Brake mode; motor winding current flowing in between both low side MOSFETs.(slow decay)

Table 1. H-Bridge Output Operation

SLEEP MODE

If both control logic input pin sets to low state(or float connection) from forward/reverse mode, the H-bridge will disabled immediately, after a short delay time (Tslp, approximately 1mS) the internal circuit also disabled and whole chip will entering sleep mode, the current consumption will drops to Islp level and outputs remains in HiZ.

The internal circuit needs an enable time (Tena, approximately 50μS) to wakes up the H-bridge from sleep mode or UVLO released. During sleep mode actives, whatever the IN1 or IN2 pin are pull-high for at least 5μS, the chip will quit from sleep mode and H-bridge will operates after Tena time.

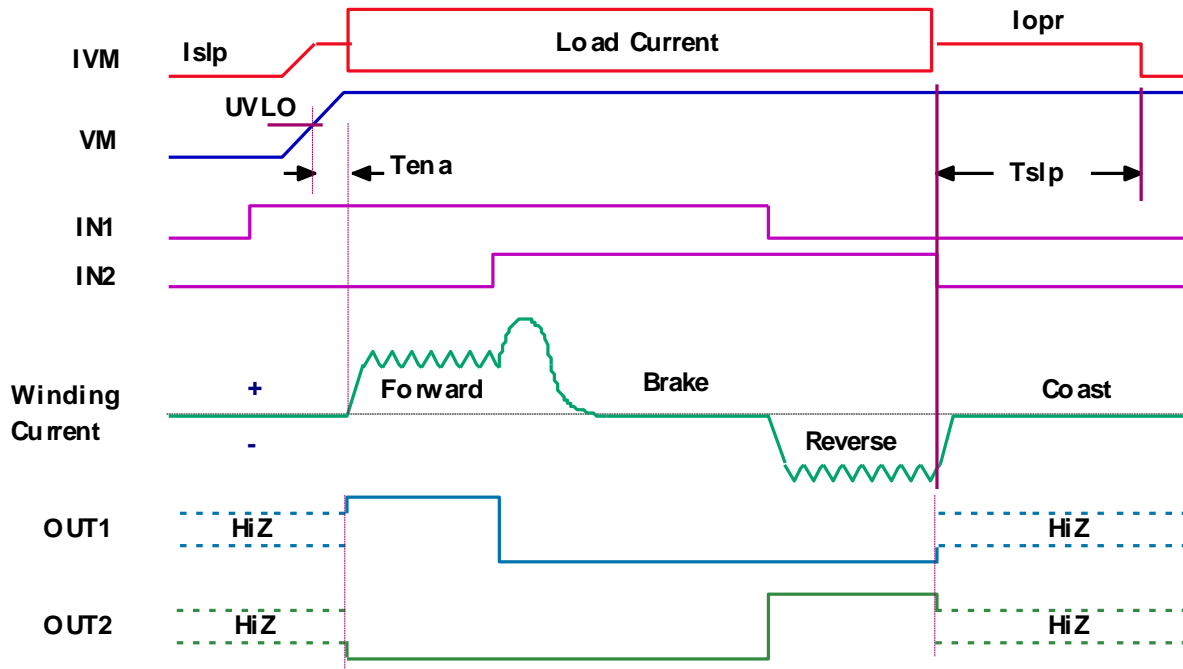


Figure 1. H-Bridge Output Mode and Control Logic Timing

PWM CURRENT REGULATION

The output current of H-bridge is based on the reference input, VREF, and the resistance of current sensing resistor placed on the ISEN pin, the current setting according to Equation 1:

$$I_{TRIP} (A) = \frac{VREF (V)}{A_v \times R_{ISEN} (\Omega)} = \frac{VREF (V)}{10 \times R_{ISEN} (\Omega)} \quad (Eq.1)$$

For example, if VREF = 2.5 V and a RISEN = 0.22Ω, the PWM current regulation mechanism will limit motor current to 1.13 Amps no matter how much load is applied. When ITRIP is reached, the H-bridge enforces the inductor current into slow decay path by enabling both low-side FETs, and it does this for a fixed off time, Toff (typically 25 μs).

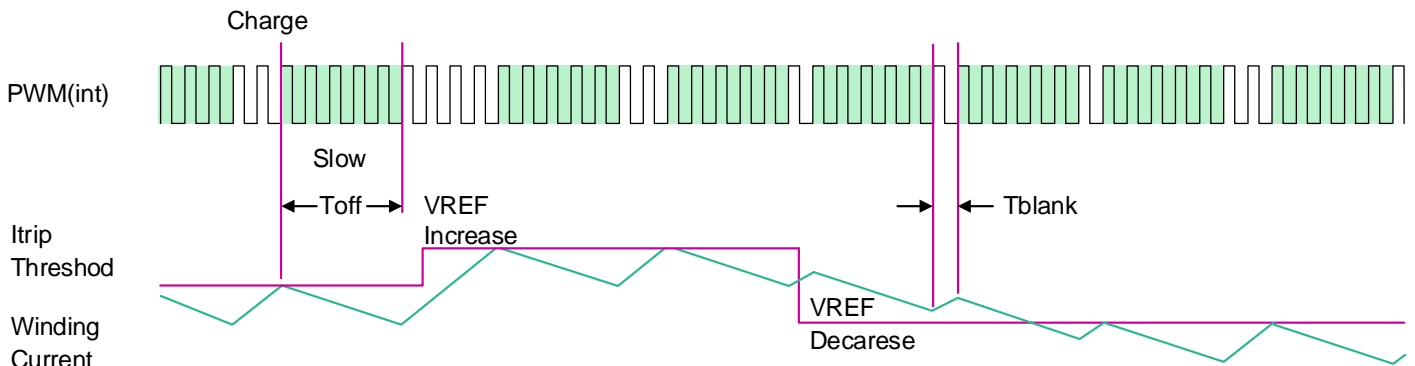


Figure 2. PWM Current Regulation Operation Period and Timing

After Toff time passes, the H-bridge output is re-enabled according to the logic states of two inputs, IN1 and IN2, and motor winding current is charging until reaching another ITRIP event, this charge time is heavily depends on the VM voltage, the back-EMF of the motor, and the inductance of the motor.

BLANKING TIME

During PWM current regulation is works, each time the H-bridge enabled, the load current level can be picked-up in the sense resistor connected in ISEN pins, the signal will delivers to comparator after a fixed delay time (T_{blank}) to avoid noises or current spike causes fault-triggered. The blanking time is fixed at $3.5\mu S$ and it also sets a minimum duty cycle of PWM in charge period.

DEAD TIME

When an output level changes from high to low, or vice versa, a dead time will automatically insert to prevent output MOSFETs shoot-through. In the dead time (T_{dt}) period, both outputs are keeps in HiZ states. If winding or inductor current is still flows during dead time inserted, the rest of current will be reset to zero through the parasitic body diode of output MOSFETs, and the voltage presents on output pin during dead time is depends on demagnetized current flow. If the current is leaving the output pin, the current will flows through the low side body diode and output potential drops below ground; if the current is entering the output pin, the current will flows through the high side body diode and output potential will exceeds the VM voltage.

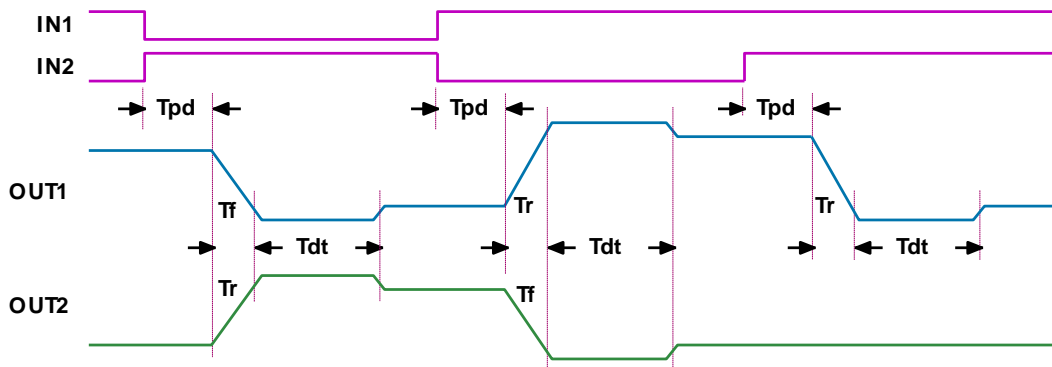


Figure 3. I/O Propagation Delay Time

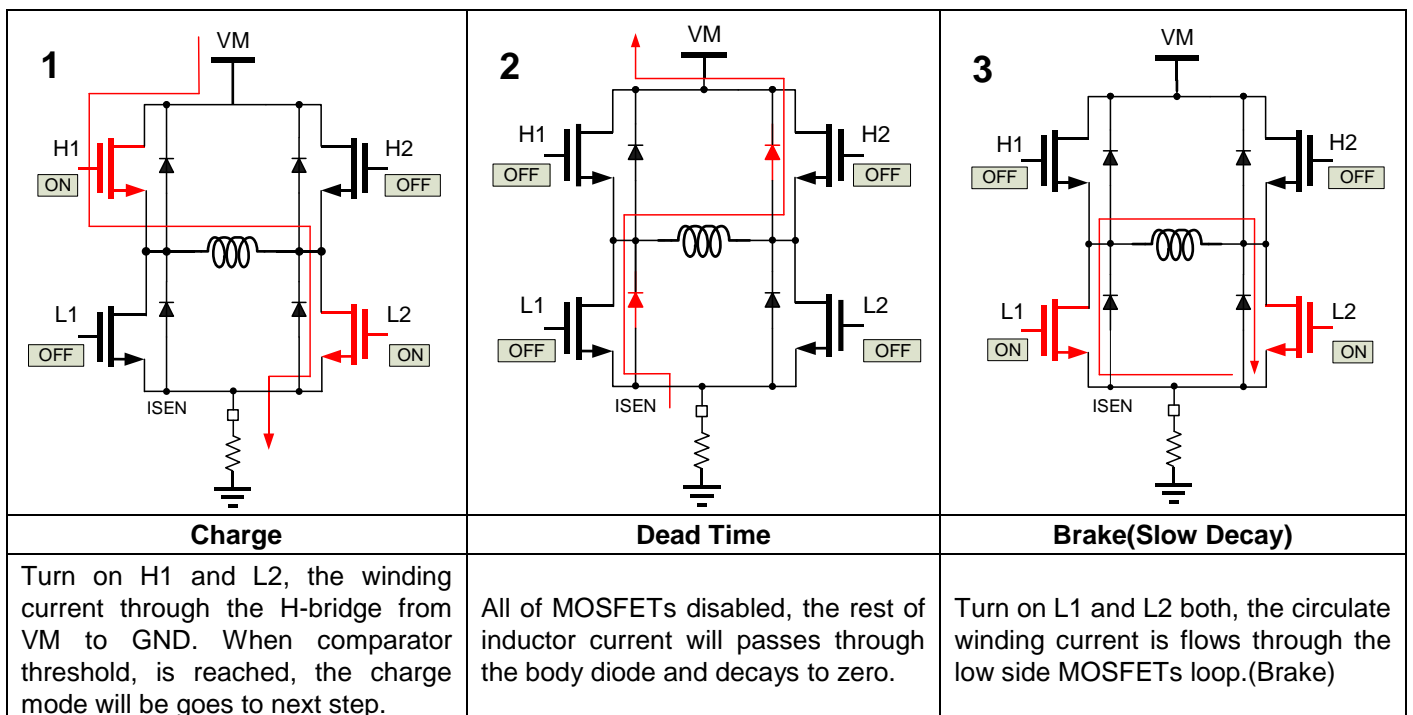


Figure 4. H-Bridge Current Paths

PROTECTION CIRCUITS

The PT2470 have fully protection function to against miss-operation events.

◆ ACROSS-LOAD SHORT CIRCUIT PROTECTION (SCP)

Across-load short-circuit detection circuit will monitor the high side output current during H-bridge in forward and reverse mode; the circuit is independent from PWM current regulation. If both output pins are connected together by external wiring, the high side inrush current exceeds protection threshold (I_{SCP}) and detected by SCP circuit, the H-bridge output will be disabled after the SCP deglitch time (T_{SCP}). The chip will remain disabled and wait for a rest time (T_{RTY}), after T_{RTY} time elapses the chip will enable again.

In brake mode, both low side MOSFET are enabled and inductor/winding current is flows inside the loop, in actually it is similar to short circuit condition, therefore the SCP detection will temporary disabled in this mode.

◆ THERMAL SHUTDOWN (TSD)

If the chip junction temperature exceeds 175°C , the H-bridge output will be turn off, until the chip temperature is cooling down to below hysteresis window, H-bridge output will be enabled again.

◆ UNDERVOLTAGE LOCKOUT (UVLO)

In Any time the VM pin voltage drops below the under voltage lockout threshold voltage, all circuitry in the chip will be disabled and internal logic will be reset. Operation will resume when VM rises above the UVLO threshold.

POWER SUPPLY CAPACITOR RECOMMENDATIONS

Consider a real world application scenario; the motor driver is designed to drives high inductance load such like motor winding or solenoid coil. If a H-bridge turns-off all of outputs during inductor current still flowing, because the inductor current would not be reset immediately, the rest of free-wheel current would re-directs and passing through the body diode of the output FET and runs into VM supply and final decay to zero after de-magnetization time. This reverse current depends on load inductance, inductor current and re-generates current from the motor due to inertia of rotor. In another case, the parasitic reactance (inductance + resistance) of power wire between the power supply and motor driver board with parasitic capacitance of PCB consists a LC resonates tank, during power supply sourcing current to the motor driver board, the VM voltage may drops quickly and parasitic LC will be trigged and shows oscillation spike if the local bypass capacitor is not sufficient.

To prevent unstable bounce or spike appears on VM bus, a high capacitance bounce absorber capacitor ($>100\mu\text{F}$) should be placed on VM bus line, it could absorb re-generates free-wheels current during DC motor brake and stabilize VM voltage during high forward/reverse motor current sources. A small MLCC $0.1\mu\text{F}$ bypass capacitor should be placed near the motor driver IC power pin, to reduce the spike causes by power line LC resonates.

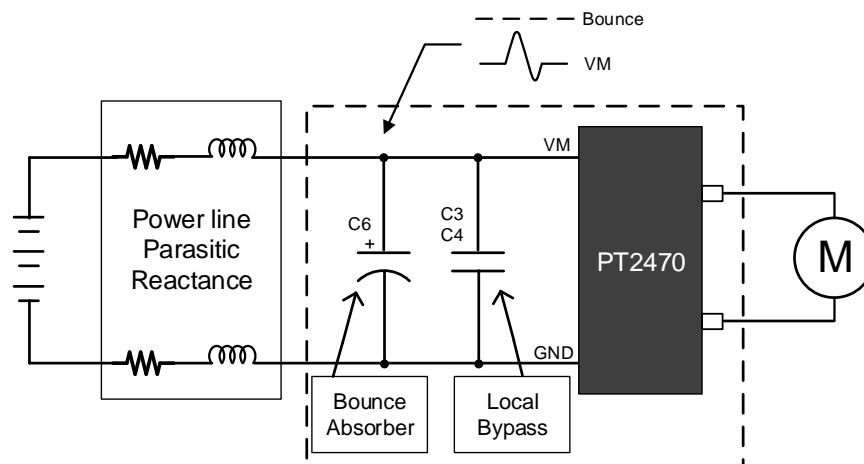


Figure 5. Motor Driver System with External Power Supply

PCB LAYOUT RECOMMENATION

The local bypass capacitor C3 should be placed near the IC power pins, and bounce absorber capacitor C2 should be placed on VM bus line. The GND plane should be placed on the component side under the chip as a low impedance power trace, and larger area of GND plane and wider cooper trace reduce the thermal resistance (θ_{JA}). The thermal pad under HSOP package should be soldered to the PCB component side and connects to the bottom side through via holes, this arrangement can further enhance the heat dissipation.

The power rating of the current sense resistor R1 is determinates by the IR drops, consider a worse case, the maximum output current is continue conducts, for example, the average output current is 2 Amps, and current sense resistance is 0.2Ω , the power dissipation of resistor is $(2^2 \times 0.2) = 0.8W$, therefore a 1watt resistor is a better choice, and sense resistor should be connected to ground plane to enhance heat dissipation.

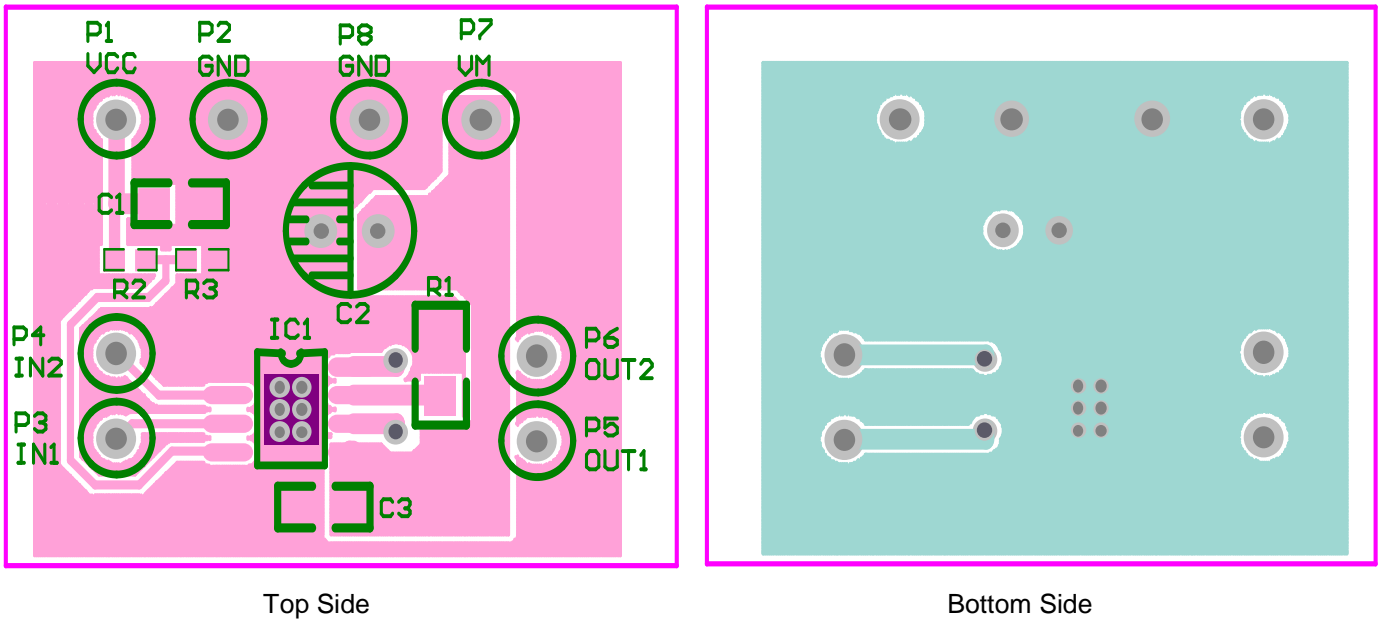


Figure 6. Simplified Layout Example

ABSOLUTE MAXIMUM RATINGS

Over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

Parameter	MIN	MAX	UNIT
Power supply voltage (VM)	-0.3	40	V
Logic input voltage (IN1, IN2)	-0.3	7	V
Reference input pin voltage (VREF)	-0.3	5.5	V
Continuous phase node pin voltage (OUT1, OUT2)	-0.7	VM+0.7	V
Current sense input pin voltage (ISEN)	-0.5	1	V
Output current		3.6	A
Operating junction temperature, T _J	-40	150	°C
Storage temperature, T _{stg}	-40	150	°C

Operating a device beyond its Absolute Maximum Ratings may cause permanent damage. These limits do not guarantee proper function or performance. Even short-term operation within Absolute Maximum Ratings but outside the Recommended Operating Conditions may lead to malfunction, reduced reliability, or shortened lifespan.

RECOMMENDED OPERATING CONDITIONS

Over operating free-air temperature range (unless otherwise noted)

Parameter	Symbol	MIN	MAX	UNIT
Power supply voltage	VM	9	36	V
VREF input voltage	VREF	0.3 ⁽¹⁾	5	V
Logic input voltage (IN1, IN2)	V _I	0	5.5	V
Logic input PWM frequency (IN1, IN2)	f _{PWM}	0	200 ⁽²⁾	KHz
Peak output current ⁽³⁾	I _{peak}		3.6	A
Operating ambient temperature ⁽³⁾	T _A	-40	125	°C

Operation between Recommended Operating Conditions and Absolute Maximum Ratings for extended periods cannot guarantee long-term reliability or normal functionality

(1) Operational at VREF = 0 to 0.3 V, but accuracy is degraded.

(2) The voltages applied to the inputs should have at least 800 ns of pulse width to ensure detection. Typical devices require at least 400ns. If the PWM frequency is 200 kHz, the usable duty cycle range is 16% to 84%.

(3) Power dissipation and thermal limits must be observed.

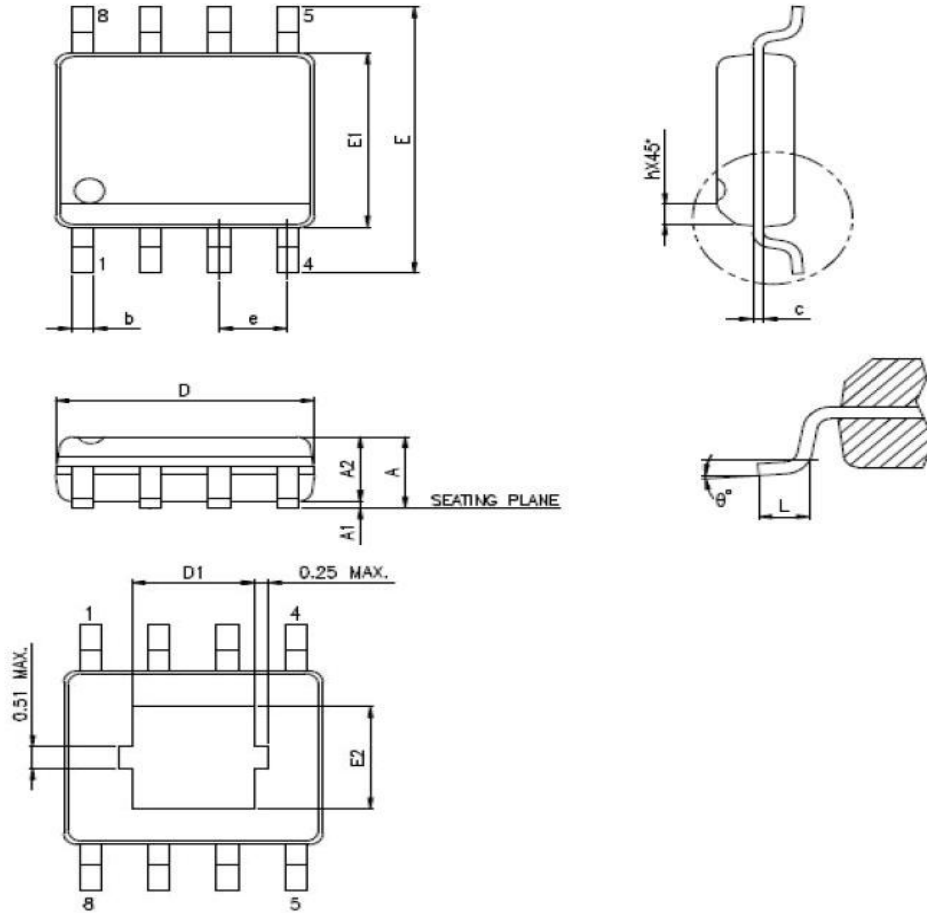
ELECTRICAL CHARACTERISTICS

TA = 25°C, over recommended operating conditions (unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
POWER SUPPLY (VM)						
VM operating voltage	VM		9		36	V
VM operating supply current	Iopr	VM = 12 V		4	10	mA
VM sleep current	Islp	VM = 12 V			8	μA
Turn-on time	Tena	VM > V _{UVLO} with IN1 or IN2 high		40	50	μS
CONTROL LOGIC INPUTS (IN1, IN2)						
Input logic low voltage	V _{IL}				0.5	V
Input logic high voltage	V _{IH}		2			V
Input logic hysteresis	V _{HYS}			0.8		V
Input logic low current	I _{IL}	V _{IN} = 0 V	-1		1	μA
Input logic high current	I _{IH}	V _{IN} = 3.3 V		33	100	μA
Pulldown resistance	R _{PD}	to GND		100		kΩ
Propagation delay	T _{PD}	INx to OUTx change		0.6	1	μS
Time to sleep	T _{slp}	Inputs low to sleep		1	1.5	mS
MOTOR DRIVER OUTPUTS (OUT1, OUT2)						
High-side FET on resistance	R _{DS(ON)}	VM = 24 V, I = 1 A, f _{PWM} = 25 kHz		250	300	mΩ
Low-side FET on resistance	R _{DS(ON)}	VM = 24 V, I = 1 A, f _{PWM} = 25 kHz		250	300	mΩ
Output dead time	T _{DEAD}			200		nS
CURRENT REGULATION						
ISEN gain	A _V	VREF = 2.5 V	9.4	10	10.4	V/V
PWM off-time	T _{OFF}			25		μS
PWM blanking time	T _{BLANK}			3.5		μS
PROTECTION CIRCUITS						
VM under voltage lockout	V _{UVLO}	VM falls until UVLO triggers		6.1	6.4	V
		VM rises until operation recovers		6.3	6.5	V
VM under voltage hysteresis	V _{UV,HYS}	Rising to falling threshold	100	180		mV
Overcurrent protection trip level	I _{SCP}	Across the Load	3.7	4.5	6.4	A
Overcurrent deglitch time	T _{SCP}			1.5		μS
Overcurrent retry time	T _{RTY}			6		mS
Thermal shutdown temperature	T _{SD}		150	175		°C
Thermal shutdown hysteresis	T _{HYS}			40		°C

PACKAGE INFORMATION

8 PINS, HSOP



Symbol	Dimensions(mm)		
	Min.	Nom.	Max.
A			1.70
A1	0.00		0.15
A2	1.25		
b	0.31		0.51
c	0.10		0.25
D	4.90 BSC		
E	6.00 BSC		
E1	3.90 BSC		
e	1.27 BSC		
D1	2.81		3.45
E2	2.05		2.56
L	0.40	0.60	1.27
θ	0°		8°

Notes: Refer to JEDEC MS-012 BA

IMPORTANT NOTICE

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